

# NSM0402AB-LL Bottom-Inlet Analog Silicon Microphone Specification

**Rev 1.0** 



#### 1. GENERAL DESCRIPTION

NSM0402AB-LL is a Silicon Microphone with analog output and bottom inlet for sound input. It is a cost-effective alternative to traditional electret condenser microphone (ECM). Provided on tap-and-reel, it is ideally suited for high volume applications. And it can be processed directly to customer's PCB using standard automatic pick-and-place equipment and surface mounted via standard solder reflow equipment.

NSM0402AB-LL can be used in (but not limited to) the following applications:

- 1. Portable communication device
- 2. Notebook and desktop
- 3. Headphone and headset accessories

#### 2. ABSOLUTE MAXIMUM RATINGS

Supply voltage: VDD to GND.....- $0.3V \sim 5V$  ESD Tolerance
The Lid Mode.....8kVThe I/O Pin Mode ......4kV

TEMPERATURE CHARACTERISTICS					
Parameter Conditions Min Typ Max Unit					
Operating Temperature		-40		+85	$^{\circ}\!\mathbb{C}$
Storage Temperature	Solder on PC board	-40		+105	$^{\circ}\!\mathbb{C}$
	In Tape and Reel	-10		+50	$^{\circ}$ C



# 3. ACOUSTIC & ELECTRICAL SPECIFICATIONS

Unless otherwise specified, test conditions are:

Typical specification are measured at  $V_{DD} = 3.0V$ 

Input sound pressure  $P_{IN} = 94dB \text{ SPL}@1kHZ$ 

Test room temperature Ta = 25 °C, Room Humidity =  $50 \pm 20$ %

A-weighting filter applied for noise floor measurement

PERFORMANCE					
Parameter	Conditions	Min	Тур	Max	Unit
Directivity		Omni-l	Direction	ıal	
Sensitivity	@1VII_ (0 dD = 1V/Da)		-38		dBv/Pa
Sensitivity Tolerance	@1 KHz (0  dB = 1 V/Pa)	-1		1	dBv/Pa
Signal-to-Noise Ratio	@1KHz $(0 \text{ dB} = 1\text{V/Pa})$		61		dB(A)
Total Harmonic Distortion (THD) @ 94dB SPL	@1KHz			0.5	%
Max Input Sound Pressure	@1KHz, THD < 10%		130		dB SPL
Power Supply Rejection (PSR)	217Hz,100m Vpp square wave		-84		dBv
	INPUT CHARACTERISTIC	CS			
Power supply Voltage		1.6		3.6	V
Sensitivity Loss Across Power Supply Voltage	Change in sensitivity from 1.6V to 3.6V power supply voltage	No change dB		dB	
Total Operation Current	1.6V-3.6V power supply		200	uA	
Standby Current	1.6V-3.6V power supply voltage			2	uA
OUTPUT CHARACTERISTICS					
Output Impedance	@1KHz $(0 \text{ dB} = 1 \text{ V/Pa})$			200	Ω



## 4. FREQUENCY RESPONSE CURVE

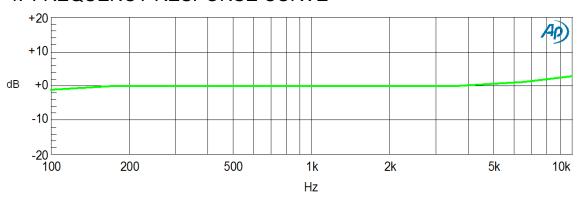
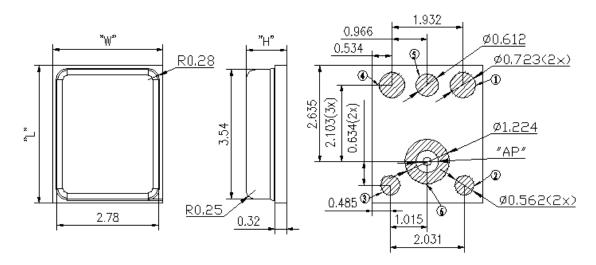


Figure 1. Typical free field frequency response (Normalized to 1 KHz)

## 5. MECHANICAL SPECIFICATIONS



ITEM	DIMENSION	TOLERANCE	UNITS
LENGTH(L)	3.76	$\pm 0.10$	mm
WIDTH(W)	3.00	$\pm 0.10$	mm
HEIGHT(H)	1.10	$\pm 0.10$	mm
ACOUSTIC PORT(AP)	Ф0.25	±0.05	mm

PIN OUTPUT		
PIN#	FUNCTION	
1	OUTPUT	
2	GROUND	
3	GROUND	
4	POWER(Vdd)	
5	GROUND	
6	GROUND	

Note:

Dimensions are in millimetre unless otherwise specified. Tolerance  $\pm 0.15$ mm unless otherwise specified

Figure 2. Detailed mechanical drawings

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## 6. RECOMMENDED CUSTOMER LANDING PATTERN

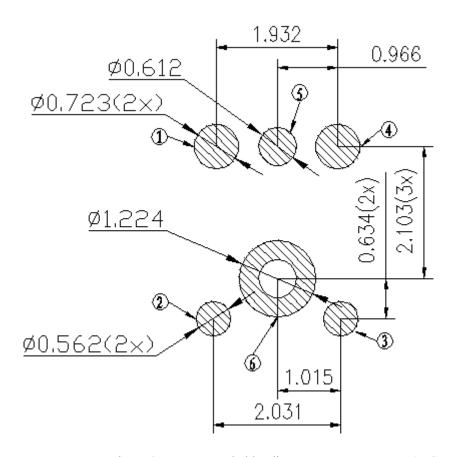


Figure 3. Recommended landing pattern on customers' PCB

## 7. RECOMMENDED INTERFACE CIRCUIT

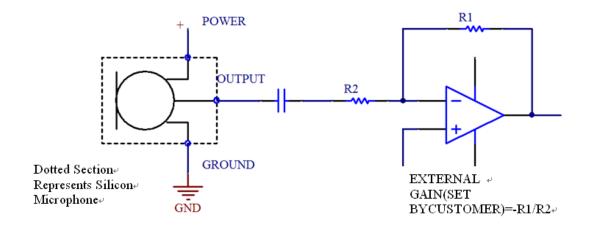
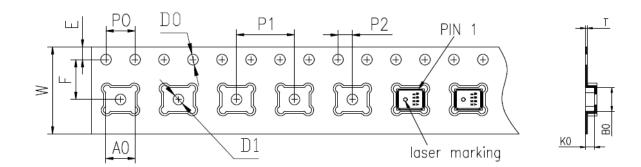


Figure 4. Recommended interface circuit for customers' applications

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# 8. PACKAGING SPECIFICATIONS



D0	1.5±0.1	W	12.0±0.30
D1	$1.5 \pm 0.1$	Е	$1.75 \pm 0.10$
A0	$4.06 \pm 0.10$	F	5.50±0.10
В0	$3.30\pm0.10$	Р0	4.00±0.10
K0	$1.35 \pm 0.10$	P1	$8.00 \pm 0.10$
Т	0.3±0.05	P2	2.00±0.10

#### Notes:

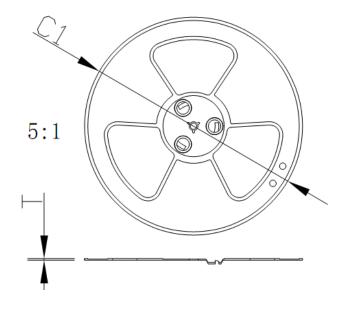
- (1) Tape & Reel Per EIA-481 standard;
- (2) Label applied to external package and direct to reel

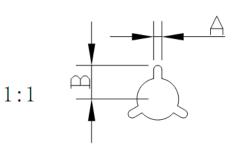
Order Part Number	Reel Diameter	Qty per Reel
NSM0402AB-LL	13"	5,000

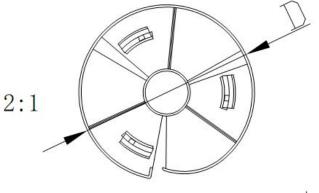
Figure 5. Tape Specification

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SPEC	13"
C1±1.0	Ф330
A±0.2	2.6
B±0.2	10.8
T±0.2	2.0

	1
1	

Avaliable Reel Size(mm)

Tape Width  $D \pm 0.5$  H+1

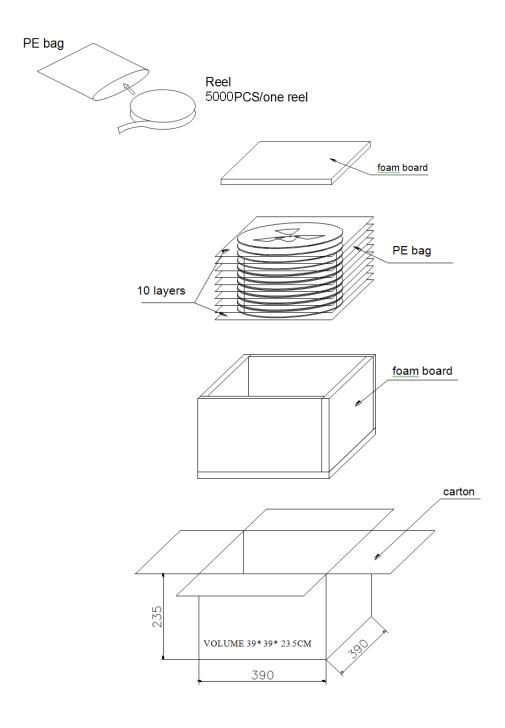
12  $\Phi 100$  12.5

5,000PCS PRODUCTS/1 reel

Figure 6. Reel Specification

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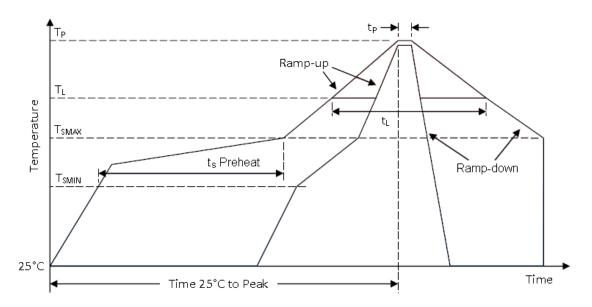
50,000 Pieces of Products per Carton

Figure 7. Packaging Specification

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## 9. SOLDER REFLOW PROFILE



Profile Feature	Pb-Free
Average Ramp-up rate $(T_{SMAX} \text{ to } T_P)$	3°C/second max.
	150°C 200°C 60-180 seconds
Time maintained above: Temperature $(T_L)$ Time $(t_L)$	217℃ 60-150 seconds
Peak Temperature (T <sub>P</sub> )	260℃
Time within 5°C of actual Peak Temperature (t <sub>P</sub> )	20-40 seconds
Ramp-down rate(T <sub>P</sub> to T <sub>SMAX</sub> )	6°C/second max
Time 25℃ to Peak Temperature	8 minutes max

Figure 8. Recommended leadless solder reflow temperature profile

#### Notes:

- 1. Vacuuming over acoustical hole of the microphone is not allowed, because the Devices can be damaged by vacuum.
- 2. To wash the board after reflow process is not allowed, because board washing and Cleaning agents can damage the device. A device should not be exposed to ultrasonic processing or cleaning.
- 3. Recommended number of reflow is no more than 5 Times.

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## 10. RELIABILITY SPECIFICATIONS

Test item	Detail	standard
Reflow Simulation	Refer to Sec.9 for solder reflow profile, total 5 times	/
Low Temperature Bias	Conditions:-40°C Duration:168 hours while under bias	IEC 60068-2-2 Test Aa
High Temperature Bias	Conditions: 105℃ Duration:168 hours while under bias	IEC 60068-2-2 Test Ba
Thermal Shock	Conditions: 100 cycles of air-air thermal shock from -40 °C to 125 °C with 15-minute soaks	IEC 60068-2-4
Temperature/Humidity Bias	Conditions: 85 °C /85%RH environment while under bias for 168 hours	JESD 22-A101A-B
Mechanical Shock	Conditions:3 pulses of 10,000g in the X,Y and Z direction	IEC 60068-2-27 Test Ea
Vibration Test	Test axis: X,Y,Z Conditions:2~400Hz 1 oct/min Test time:15mins per axis Use fixture during the testing	IEC 60068-2-6
Drop Test	Conditions: For each sample, drop by all corners, edges, surfaces respectively. Steel floor. Drop height: 1800mm.	IEC 60068-2-32
ESD	Conditions:  ±8KV direct contact to the lid when unit is grounded, ±4KV direct contact to the I/O pins. 10 times	IEC 61000-4-2

Note: Immediately after reliability test, the samples shall be stored under climatic conditions such as that normally exist in ordinary rooms or laboratories. Unless otherwise noted, the recovery period shall be 2 hours at least before performance testing. After test condition is performed, the sensitivity of the microphone shall not deviate more than 3dB from its initial value.

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NSM0402AB-LL

#### 11. REVISION HISTORY:

Version	Date	Description	Change from	Change to
1.0	14/02/2014	Initial release		

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